

(5298-04500

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re Application of:

Li, et al.

Serial No. 09/849,047

Filed: May 4, 2001

For:

BURIED LAYER SUBSTRATE

ISOLATION IN INTEGRATED

CIRCUITS

Group Art Unit: 2822 Examiner: Lewis, M.

Atty. Dkt. No. 5298-04500

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Box/Non-Pee Amendment, Commissioner for Patents, Washington, D.C. 20231, on the date 20231, on the date indicated below:

November 13, 2002

Date

AMENDMENT; RESPONSE TO OFFICE ACTION MAILED AUGUST 14, 2002

Box: Non-Fee Amendment Commissioner for Patents Washington, D.C. 20231

Dear Madame:

This paper is submitted in response to the Office Action mailed August 14, 2002 to further highlight reasons why the application is in condition for allowance.

Please amend the case as follows.

IN THE SPECIFICATION

Please replace pg. 15, line 11 - pg. 16, line 3, with the amended paragraph below. A "marked up" version of this paragraph is included in Attachment A.